



Interfacial Transport Properties in Metal-Molecule-Semiconductor Diodes

Julia W. P. Hsu

Sandia National Laboratories

W. Li, K. Kavanagh (*Simon Fraser*)

Y. Jun, X. Y. Zhu (*Univ. of Minn.*), D. A. Krapchetov, D. A. Fischer, Y. L.
Loo (*UT-Austin*), C. Highstrete, C. M. Matzke, M. Clift, A. A. Talin, F.
Leonard, S. Faleev (*Sandia*),

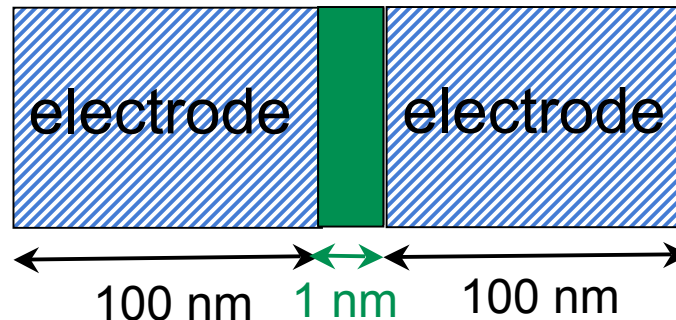
M. D. Halls, K. Raghavachari (*Indiana Univ*)

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Background

- Molecular electronics are targeted for applications in computing, memory, & sensing
- These applications require passing current through the molecules/molecular layers, hence making **electrical contacts**



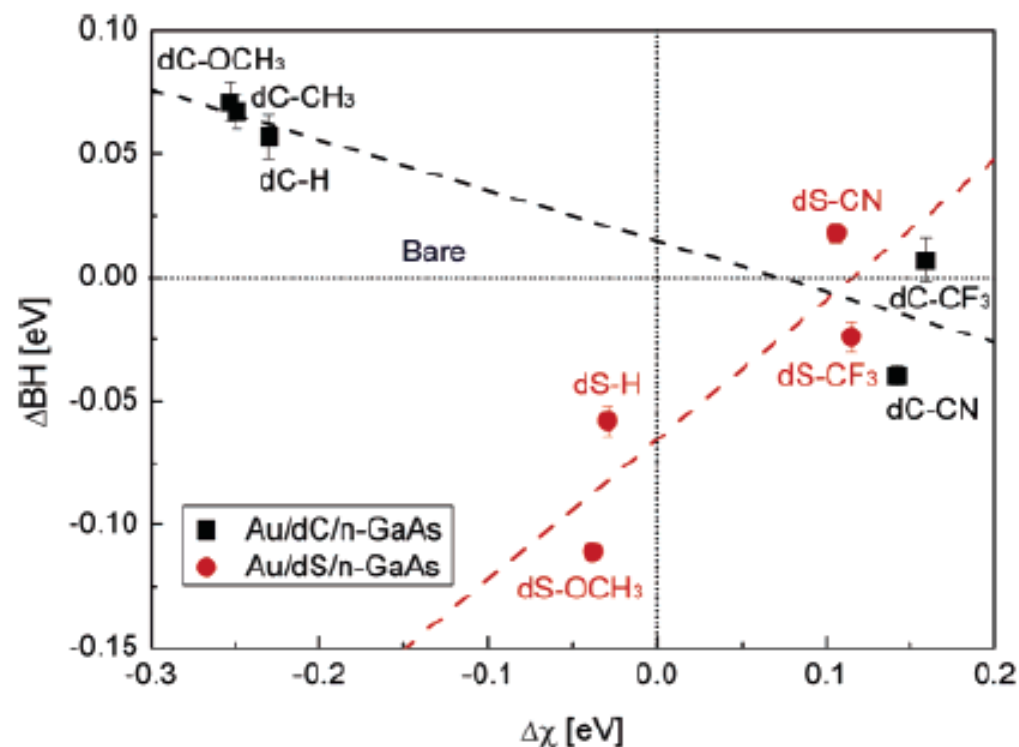
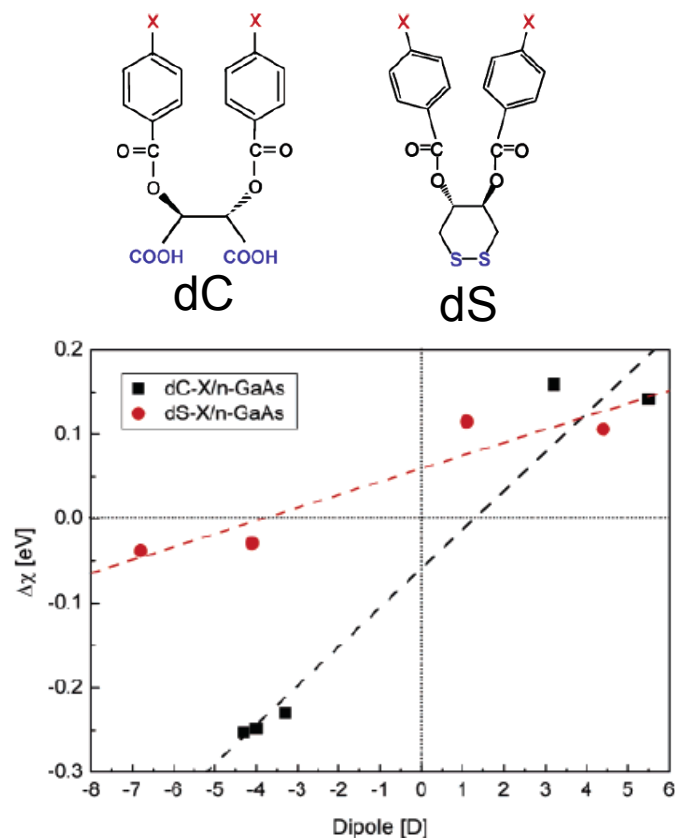
1. The deposition of the top contact could change the monolayer, induce dipole, change band alignment, etc
2. The active molecules are sandwiched between 2 electrodes and not easily accessible



Motivation

Change in monolayer

Haick, JPCB 109, 9622 (2005)



- Hence, there is a need to **probe** electrical transport across the **buried interface** in finished devices
- Few techniques are available



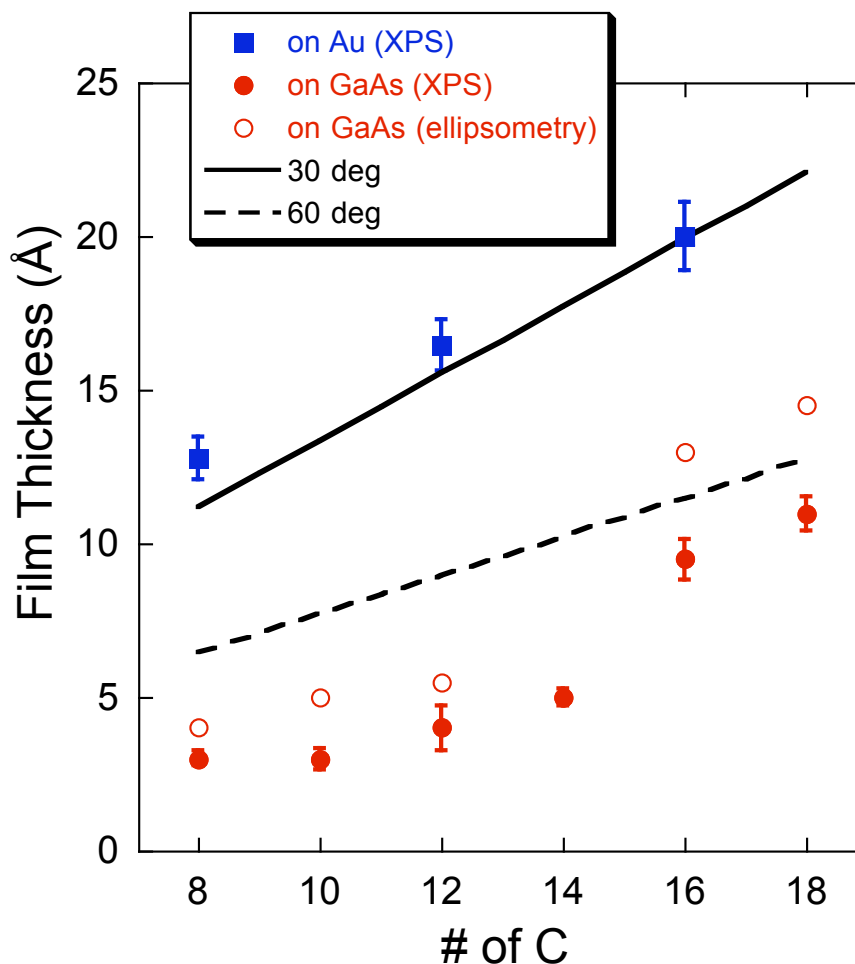
Outline

- Formation of Thiol and Dithiol Monolayers on GaAs (001)
 - Model system for molecular-semiconductor hybrid electronics
- I-V-T Measurements of Molecular Diodes
- Ballistic Electron Emission Microscopy (BEEM)
- BEEM Images & Spectra
 - Control (Au/GaAs)
 - Hexadecanethiol (Au/C16MT/GaAs)
 - Octanedithiol (Au/C8DT/GaAs)
- Interpretation of BEEM results
- Difference between C8DT and C16MT

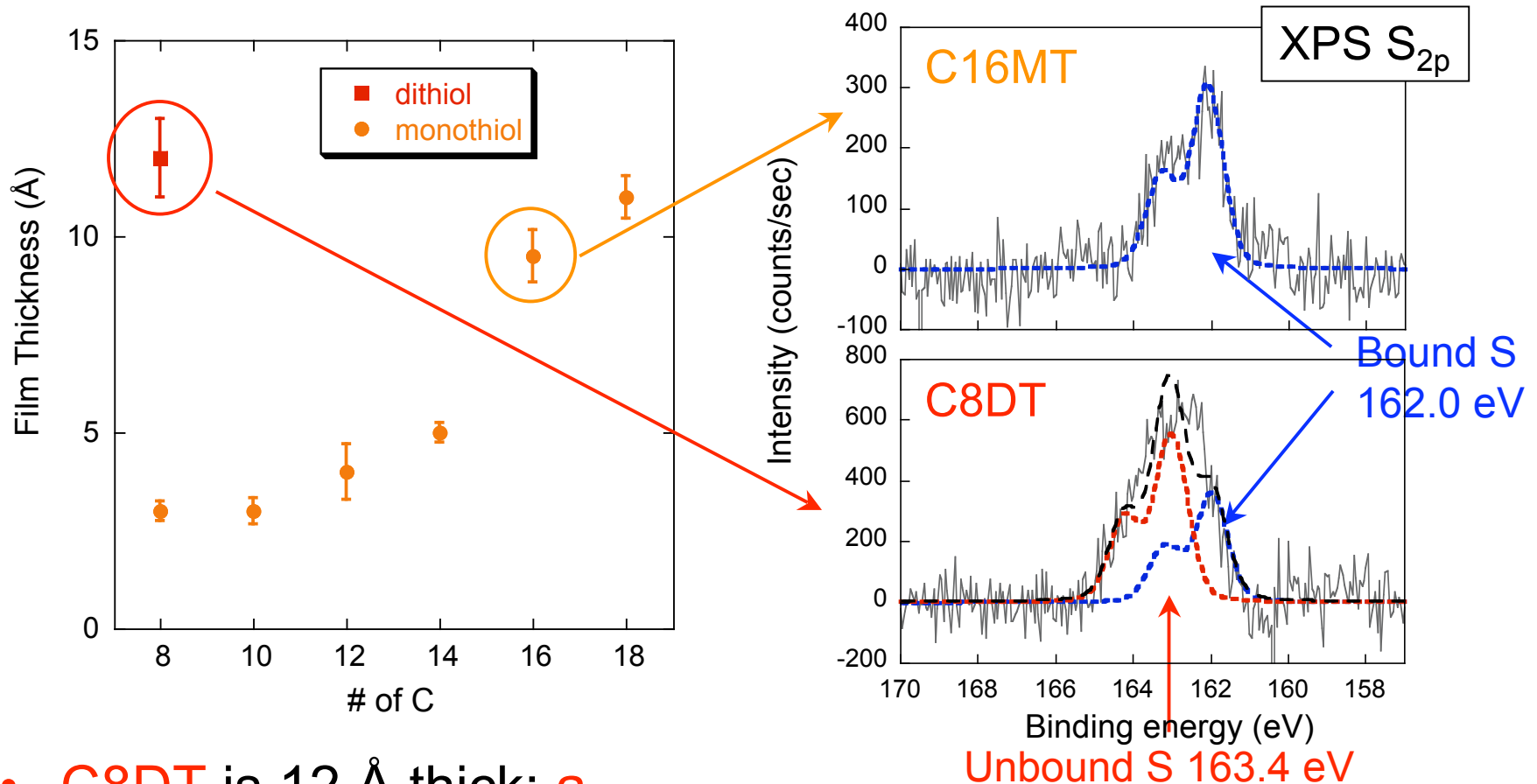


Thiol formation on GaAs

- XPS (attenuation of Ga_{3d}), ellipsometry
- Previous works limited to C18MT
- Short molecular length thiols ($n \leq 14$) do not form good monolayer: small C signal, tendency to form oxides
- Long molecular length ($n \geq 16$) consistent with 60° angle



C8DT Formation on GaAs

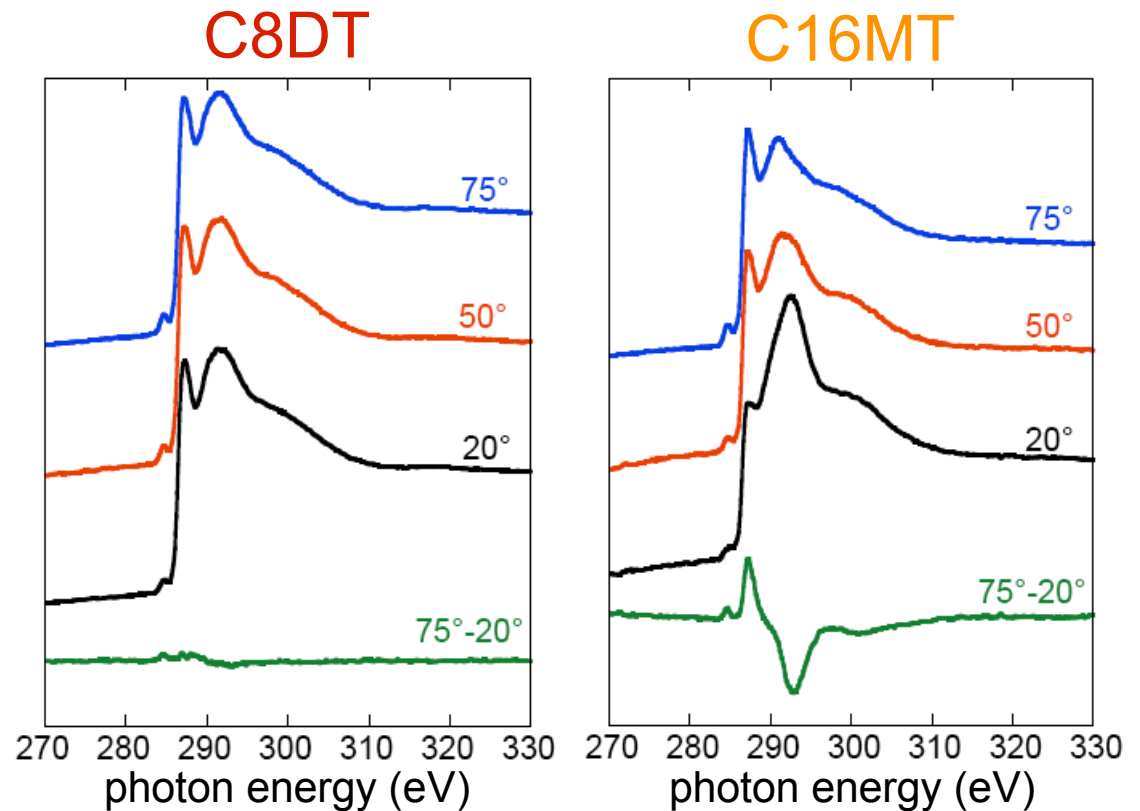
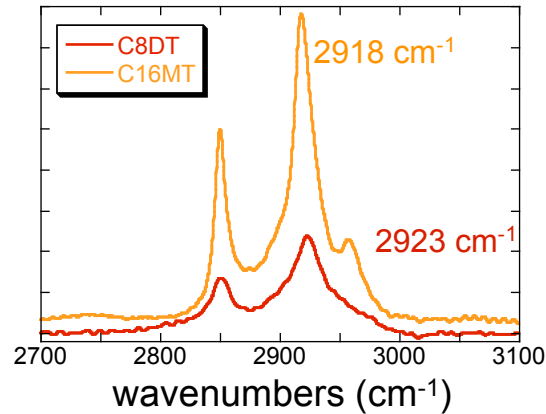


- C8DT is 12 Å thick: a dense monolayer w/ orientation almost normal to surface!

- C8DT: B:UB = 1 : 1.45; consistent with 11 Å film
- No S-O or S-S



FTIR & NEXAFS Results

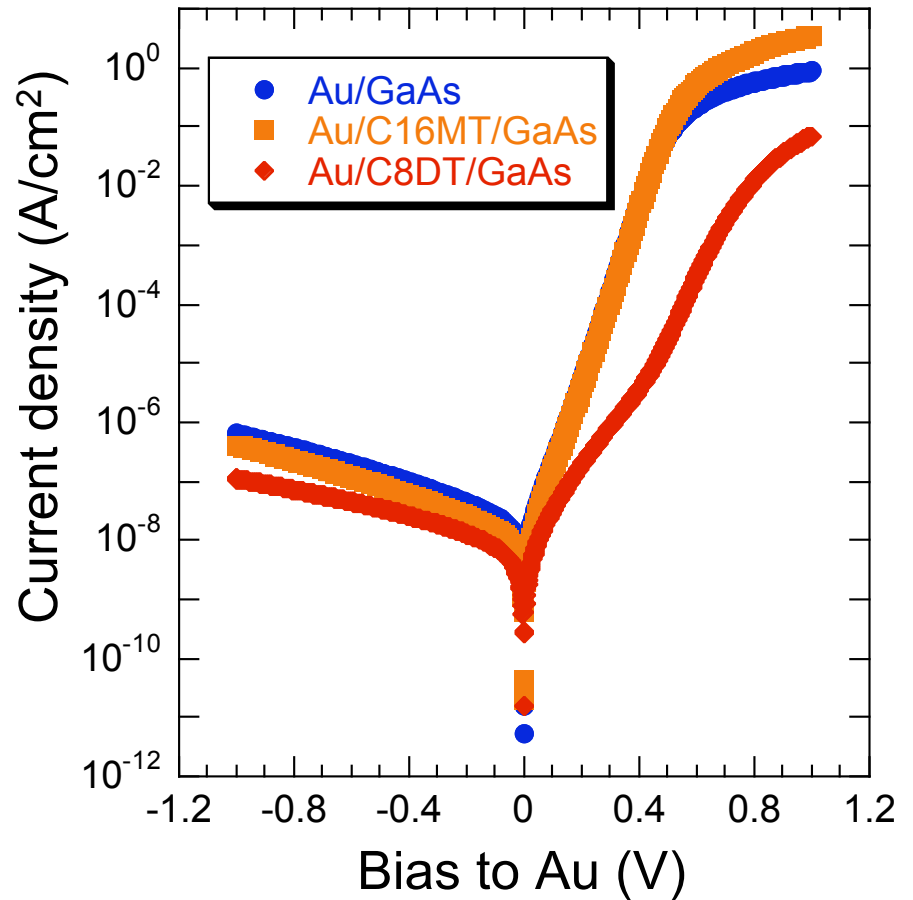


- C8DT does not show in-plane orders.
- C16MT exhibit in-plane order with $\sim 35^\circ$ tilt on average.
- How to reconcile with XPS and ellipsometry results?



Room Temp I-V

- Au-molecule-GaAs diodes (125 μ m - 1mm diameter), where molecule = C8DT & C16MT
- Control: Au/GaAs
- n-GaAs (Si doped: 2E17 cm⁻³)
- Top Au contacts made by e-beam evaporation (direct, 10 Å/s)
- No significant difference in Schottky barrier heights, but n increases

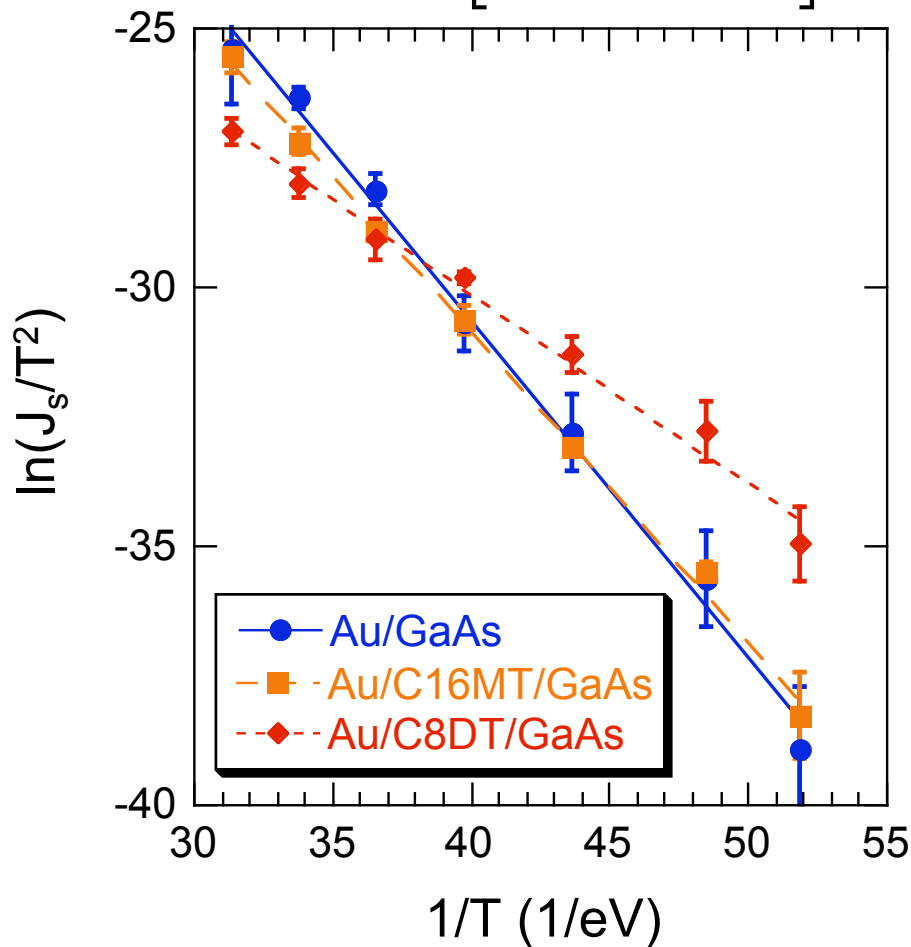


$$J = A^{**} T^2 \exp\left(-\frac{q\phi_{bn}}{kT}\right) \left[\exp\frac{qV}{nkT} - 1 \right]$$



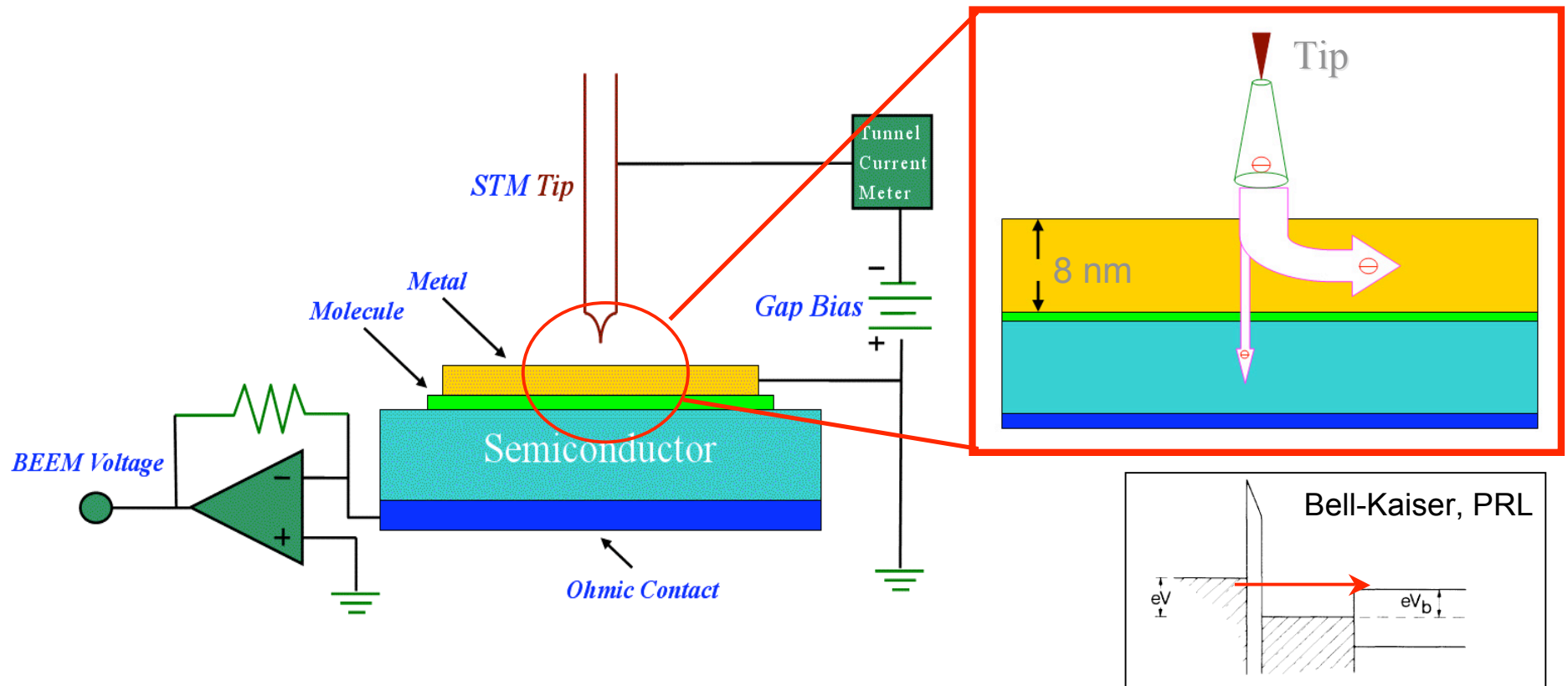
Temperature Dependence

$$J = J_s \left[\exp \frac{qV}{nkT} - 1 \right]; J_s = A^{**} T^2 \exp \left(-\frac{q\phi_{bn}}{kT} \right)$$



- C16MT diodes are similar to control; C8DT diodes are different
- ϕ_{bn} obtained from I-V-T are substantially smaller than RT values (0.65, 0.6, 0.36 eV)
- A^{**} are small compared to theoretical value (10^{-2} , 10^{-3} , 2×10^{-7} A/cm²/K²)

Ballistic Electron Emission Microscopy



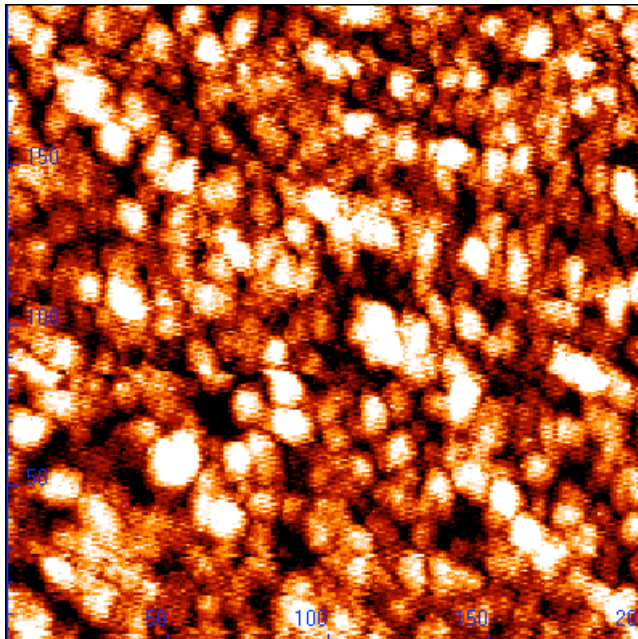
- Spatially resolved (10-20 nm) measurement
- No applied bias (< 10 mV) across the molecules
- BK model $I_c = R I_t C (V - V_b)^2$ $I_t \sim \text{nA}$; $I_c \sim \text{pA}$



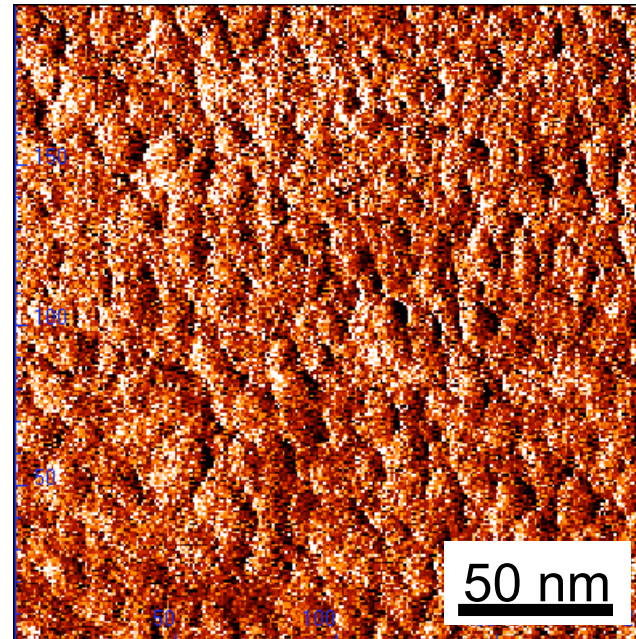
Control (Au/GaAs)

STM (topography)

$V_t = -2.1\text{V}$, $I_t = 20\text{ nA}$



BEEM



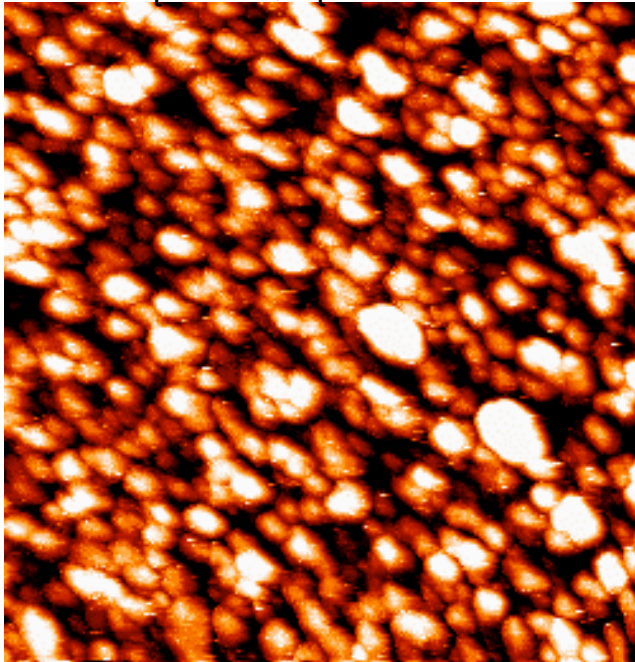
- More or less uniform BEEM signal with some grain to grain variations
- Threshold **0.87 V**, consistent with other Au/GaAs BEEM results



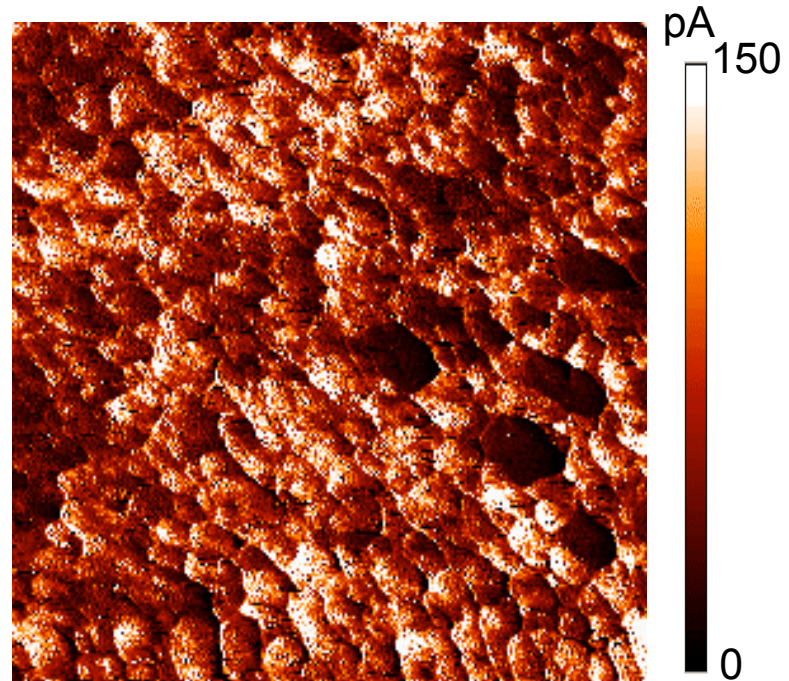
Au/C16MT/n-GaAs

STM (topography)

$V_t = -2$, $I_t = 20$ nA



BEEM



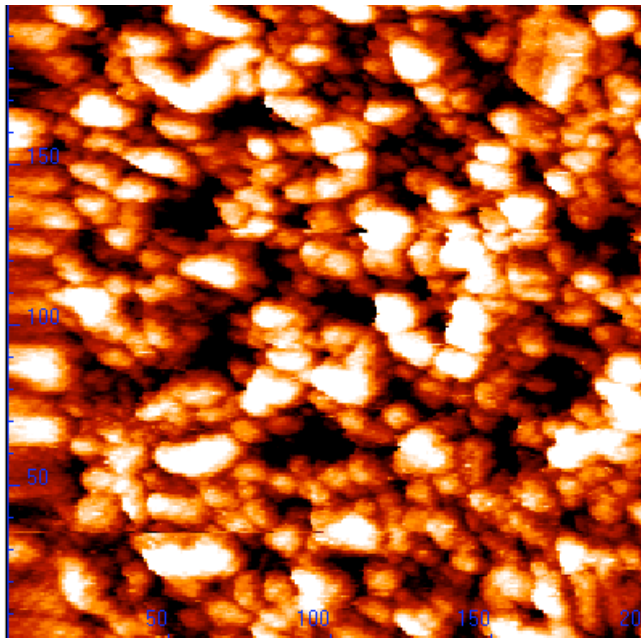
- Uniform BEEM signal, similar to Au/GaAs
- Threshold is **1.1V**, not 0.87V of Au/GaAs



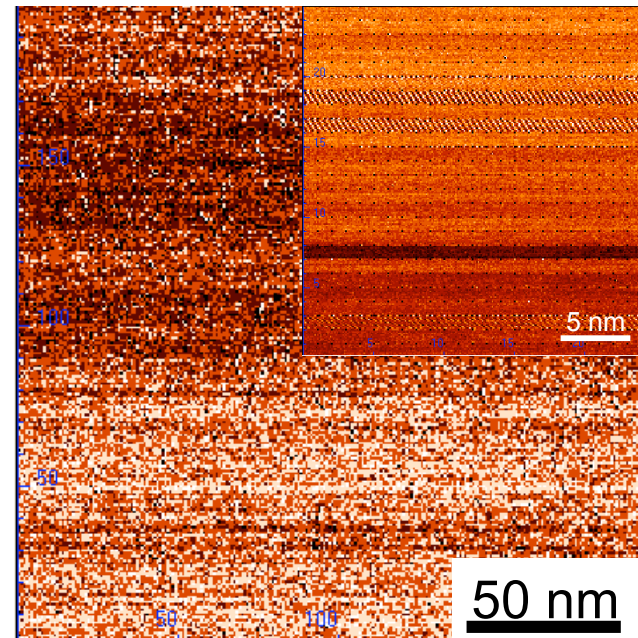
Au/C8DT/GaAs

STM (topography)

$V_t = -1.0\text{V}$, $I_t = 20\text{ nA}$



BEEM



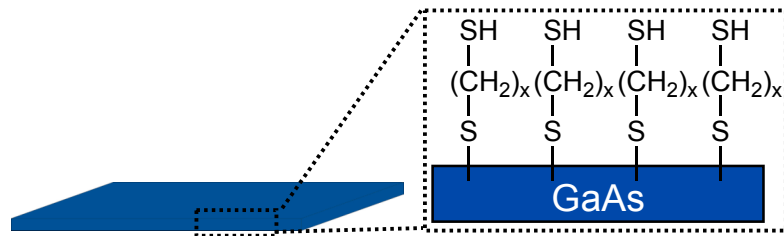
- Most areas have no BEEM signal at all
- Whenever there is a BEEM signal, the threshold is **1.5V**, not 0.87V of Au/GaAs, nor 1.1V of C16MT



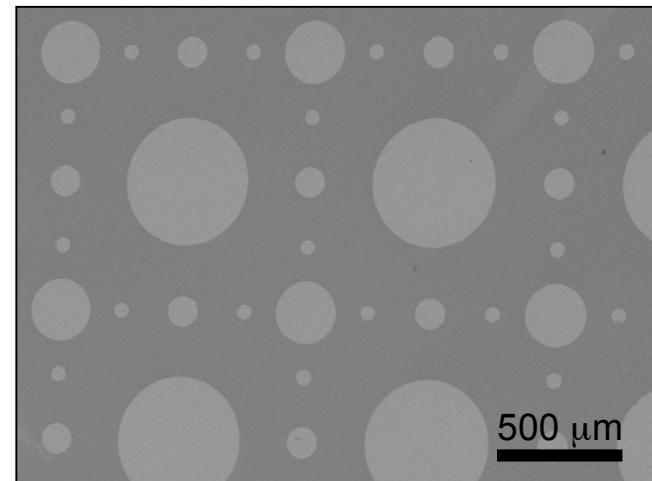
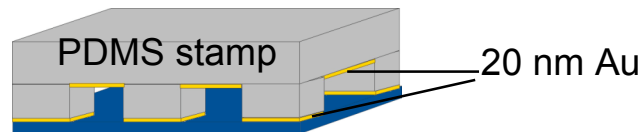
Nanotransfer Printing (nTP)

Loo, JVST B20, 2853 (2002)

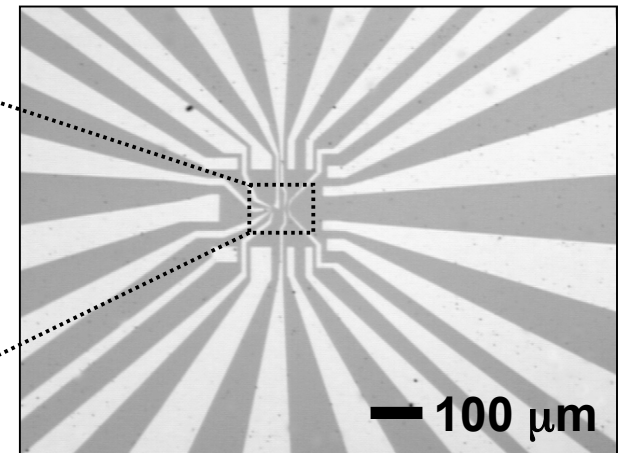
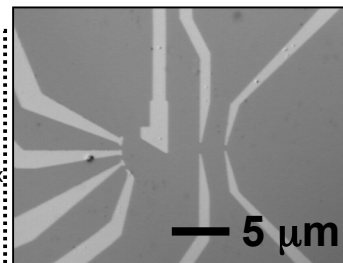
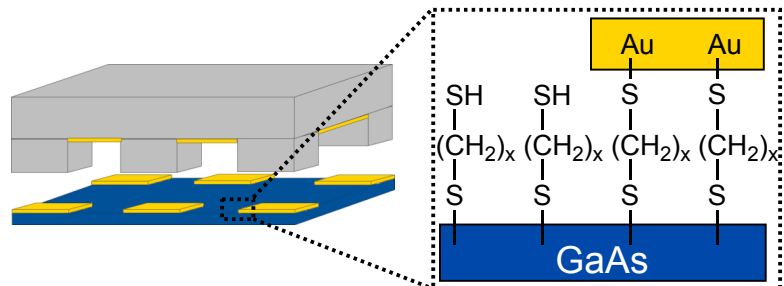
(a) Etch oxide; deposit dithiol layer



(b) Bring stamp into contact with substrate



(c) Remove stamp; complete nTP



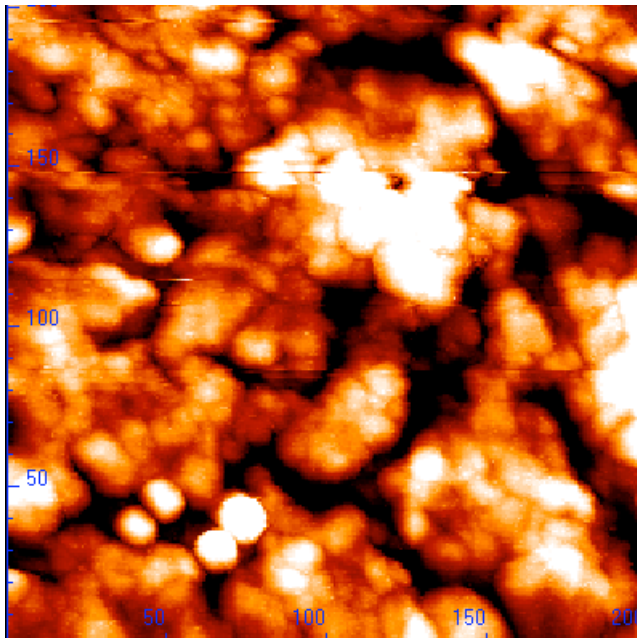
Pass Scotch tape test!!! \Rightarrow Chemical bonding



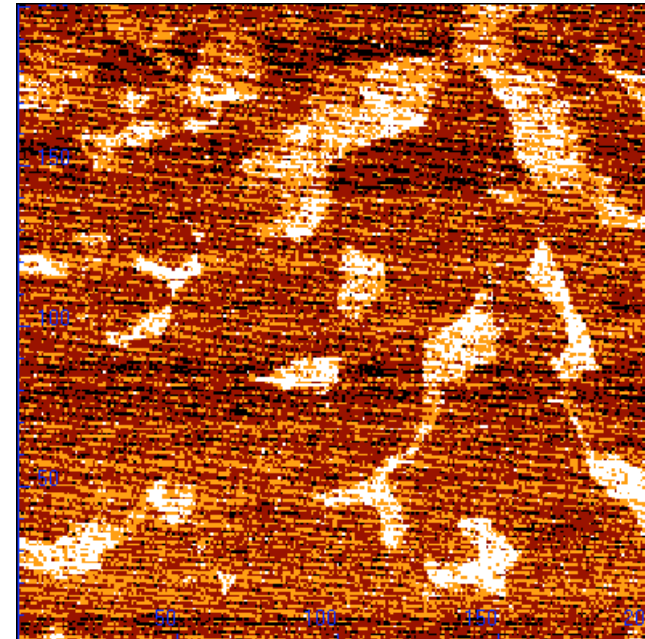
nTP (Au/C8DT/GaAs)

STM (topography)

$V_t = -1.8\text{V}$, $I_t = 20\text{ nA}$



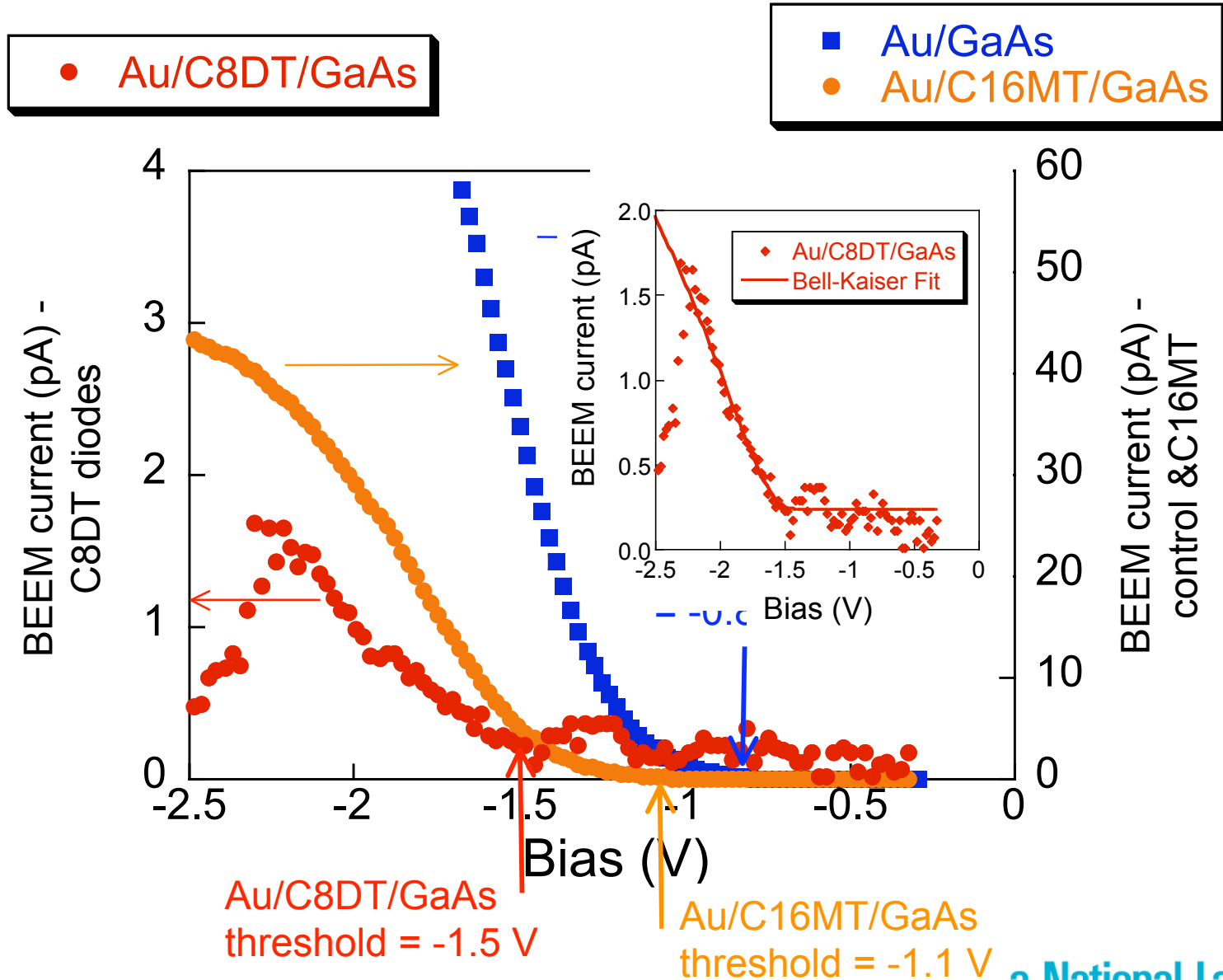
BEEM



- Some regions do show BEEM signals in patches
- Larger BEEM signal in depressions
- **Threshold 1.45 V**
- BEEM signals disappear after 3 scans



BEEM Spectra





Summary of Experimental Results

Very consistent

	RT I-V Barrier (V)	BEEM Threshold (V)	BEEM Image	BEEM Spectra
Control	0.71-0.83 n=1.47-1.12	0.86	uniform	monotonic
C16MT	0.74-0.80 n=1.89-1.37	1.1	uniform	monotonic
C8DT	0.74-0.84 n=2.52-1.49	1.5	Spotty (agree with low A ^{**})	I drops above -2V

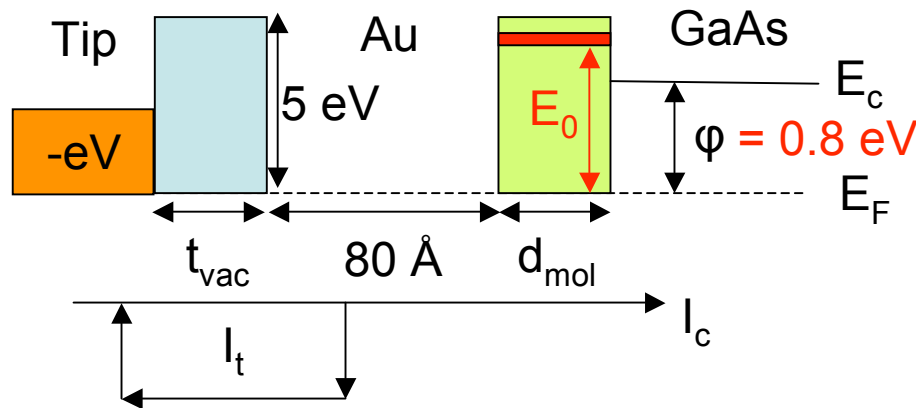
Sample (GaAs) Dependent



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Double-barrier Model



Approach: Solve Schrodinger's equation analytically in 1D, calculate transmission probability $T(E)$, tunneling current (I_t) and BEEM current (I_c).

$$I_t(V) = \int T_{vac}(E) [F_{tip}(E - eV) - F_{Au}(E)] dE$$

$$I_c(V) = \int T_{tot}(E) [F_{tip}(E - eV) - F_{GaAs}(E)] dE$$

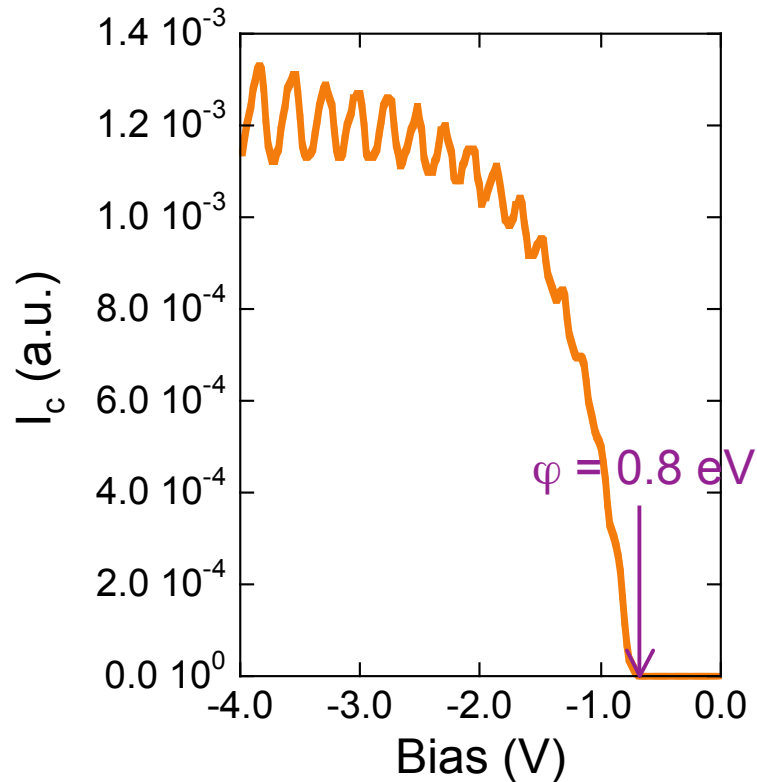
$$T_{tot}(E) =$$

$$\begin{cases} T_2(E) & |E - E_0| > 2\sigma \\ T_{vac}(E) \times T_{mol}(E) & |E - E_0| < 2\sigma \end{cases} \quad T_{mol}(E) = f \exp \left[\frac{-(E - E_0)^2}{\sigma^2} \right]$$



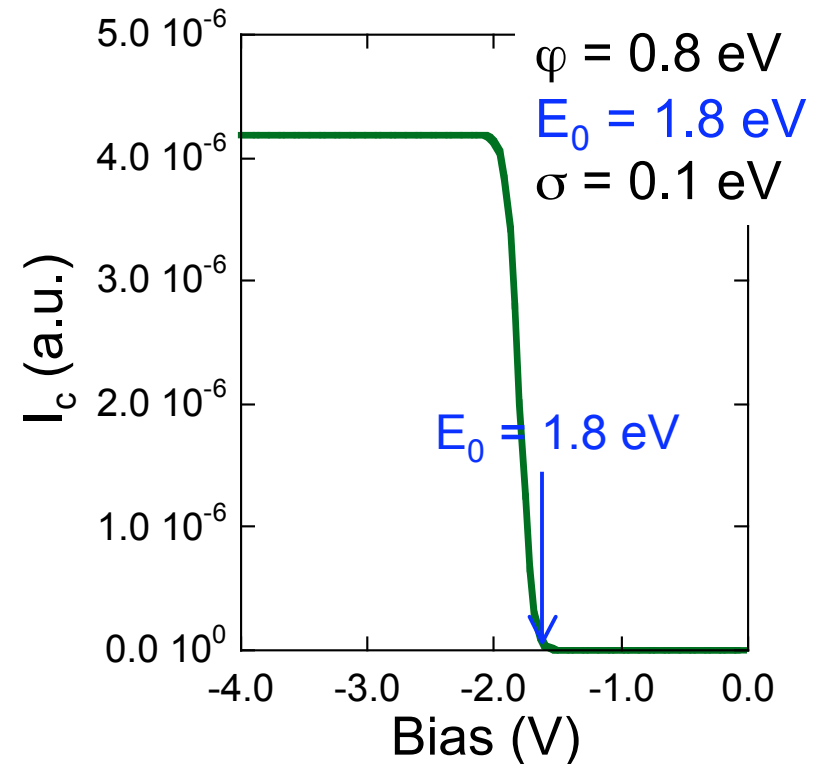
No Molecular Levels constant current

$$\varphi = 0.8 \text{ eV}; t_{\text{mol}} = 5 \text{ \AA}$$



- BEEM threshold determined by φ
- I_c saturates but does not decrease
- Oscillation due to thin Au

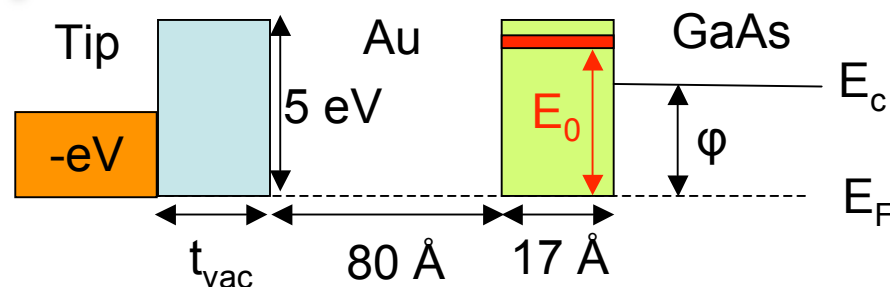
With Molecular Levels but constant height



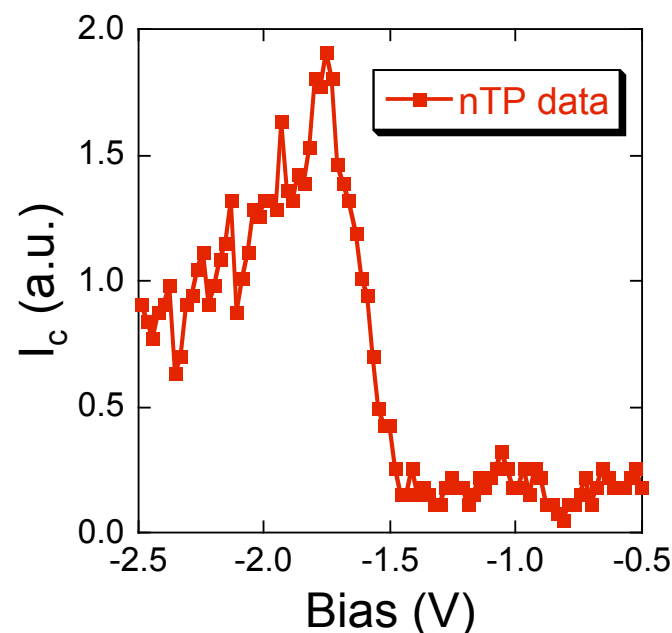
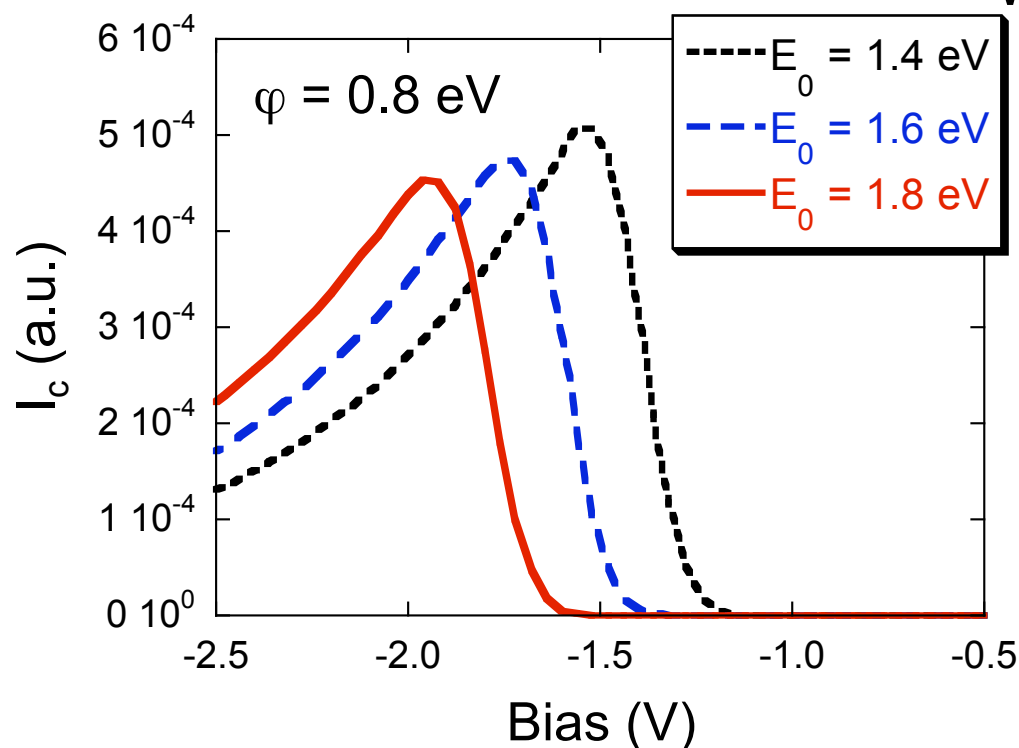
- BEEM threshold determined by E_0
- I_c saturates but does not decrease
- If the level is localized, the same behavior with lower I_c (smaller f).



With Molecular Level (constant current)



- BEEM probes lowest unoccupied states
- I_c decreases due to constant current feedback and finite width of the molecular level

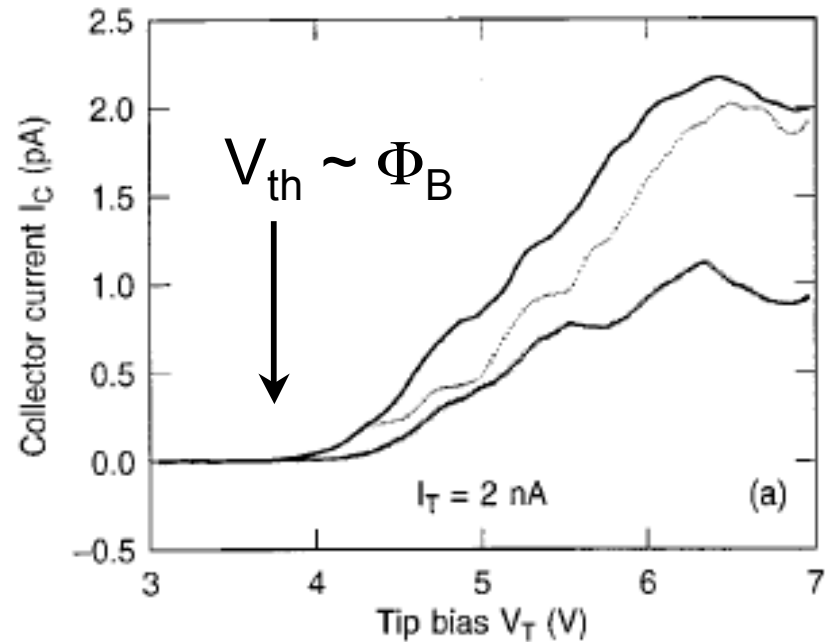
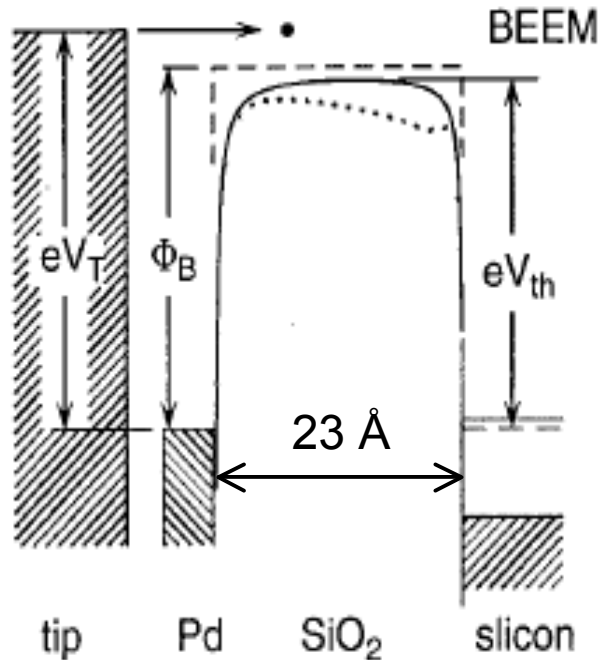


JPCB **109**, 6252 (2005)



Previous MIS Results

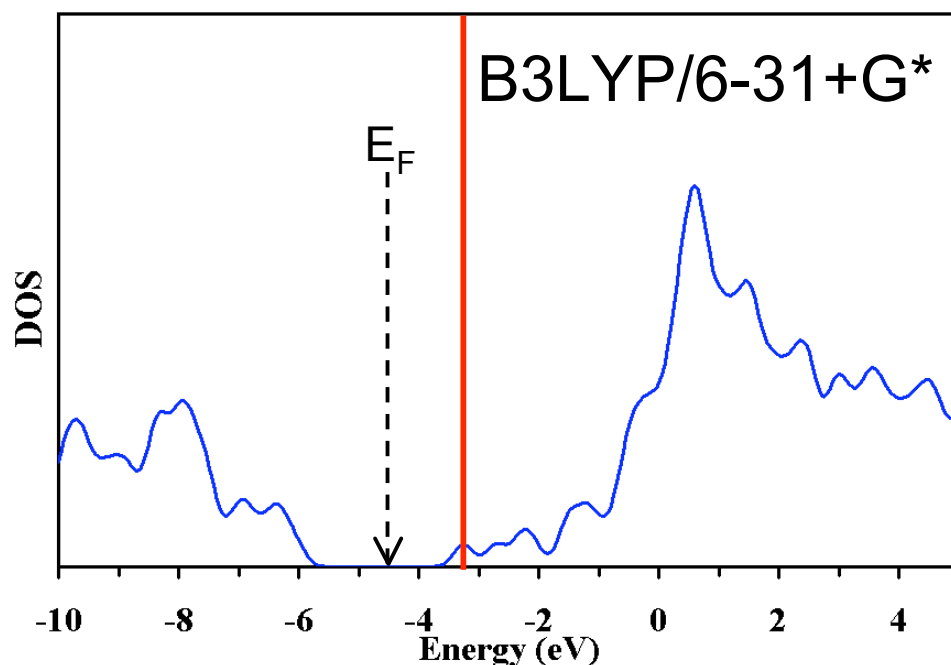
•R. Ludeke and A. Schenk, *J. Vac. Sci. Technol. B*, Vol. 17, No. 4, Jul/Aug 1999



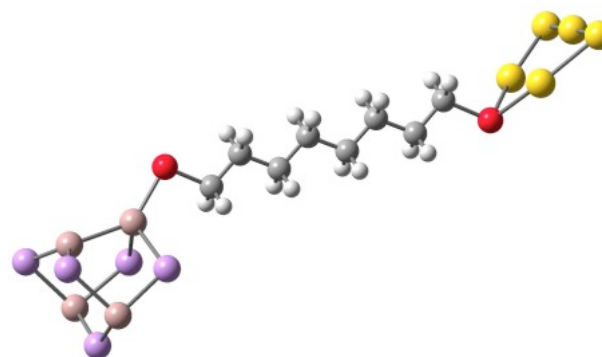
BEEM threshold determined by the energy difference between E_F of metal and conduction band of insulator



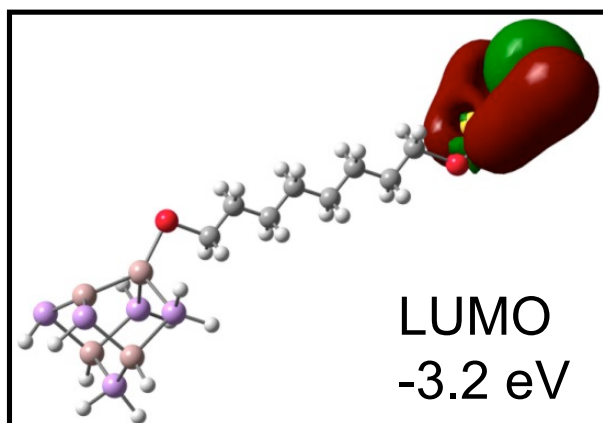
Candidate for MO at E_0 : Electronic Structure Calculation



JPCB **109**, 5719 (2005)



“HOMO-LUMO” gap = 3 eV



- LUMO ~ 1.5 - 2 eV above E_F
- Localized at Au interface:
small f
- S bond to Ga; Exp: S bond to
As?

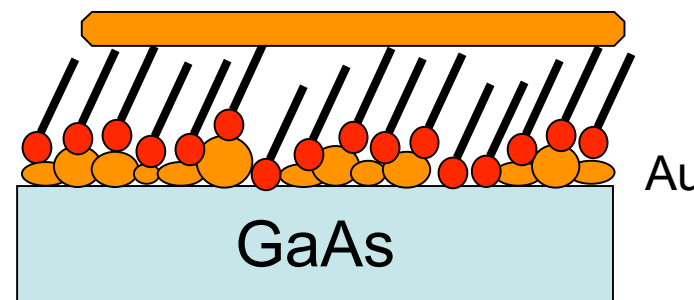


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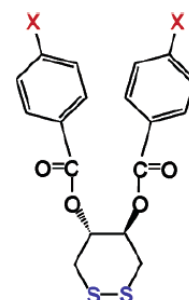
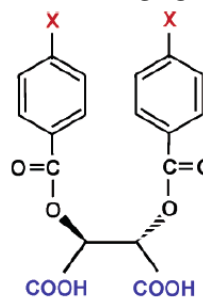


Why are C8DT & C16MT diodes different?

- Au-S vs. Au-CH₃
- Au can penetrate through C16MT layer to GaAs interface
- Recent results indicate Au diffusing to GaAs interface (Cahen, Walker & Janes)
- Degree of penetration depends on evaporation conditions
- Expect less penetration for dithiol



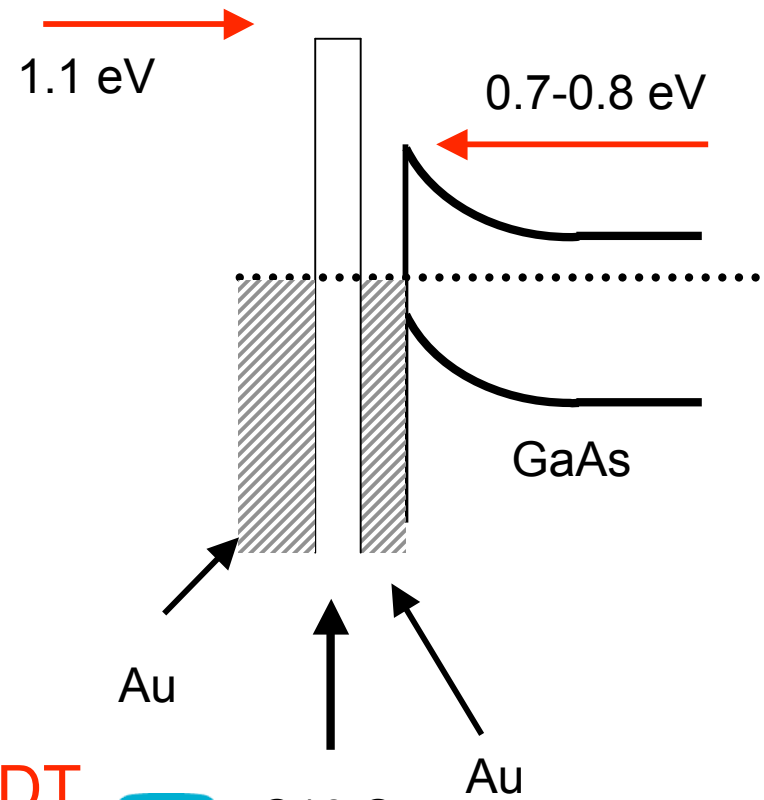
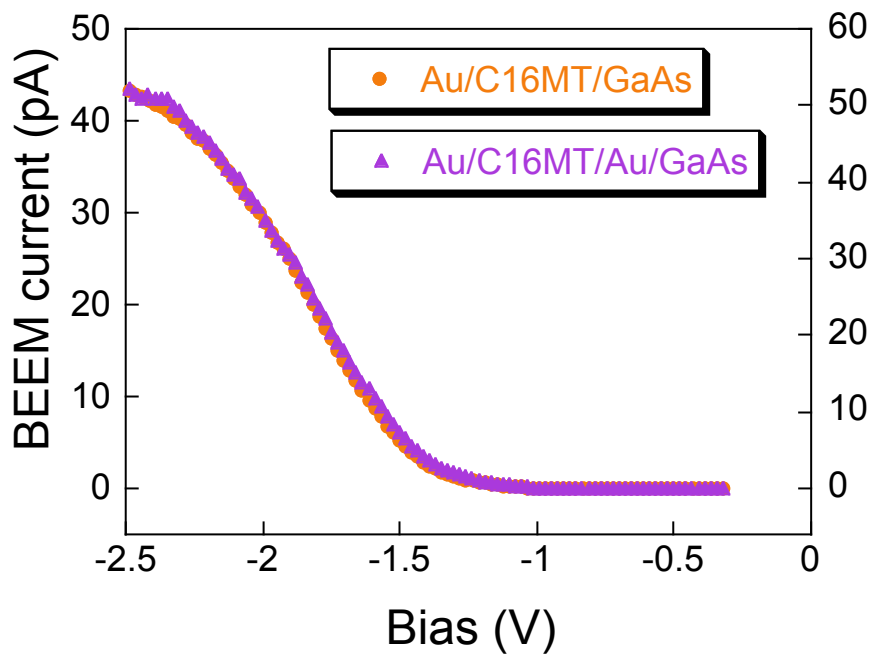
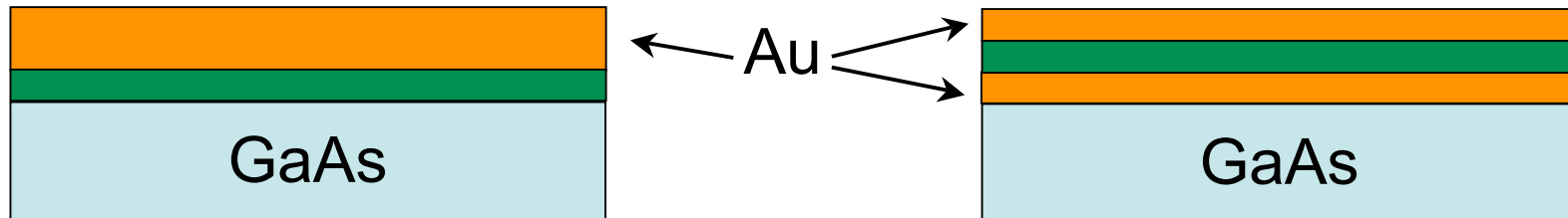
Haick, JPCB 109, 9622 (2005)



As-S-Au
and/or
As-O-Au

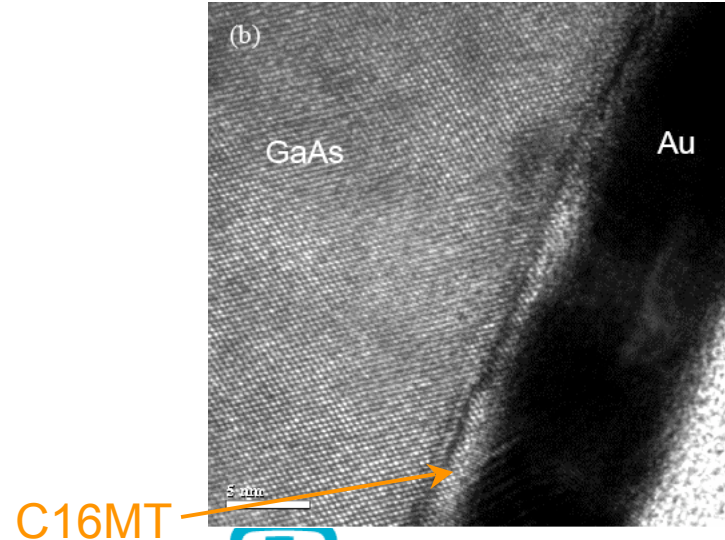
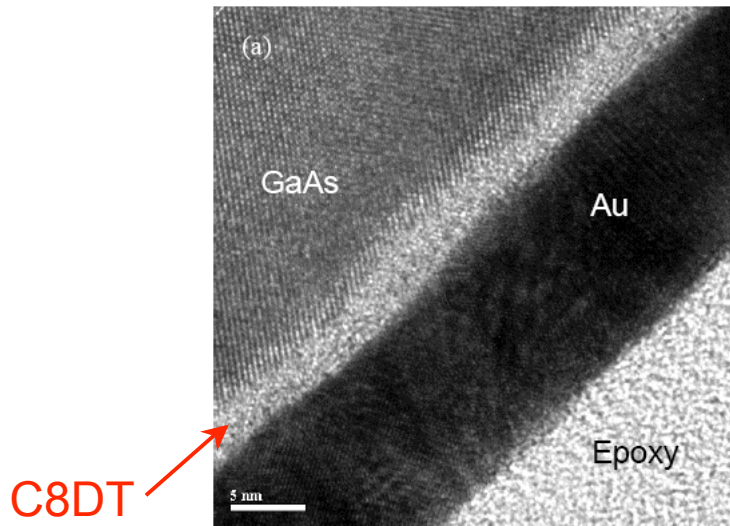
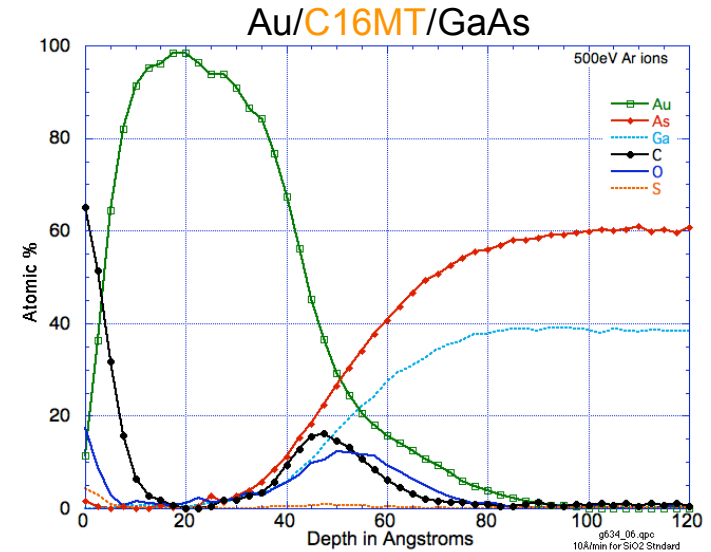
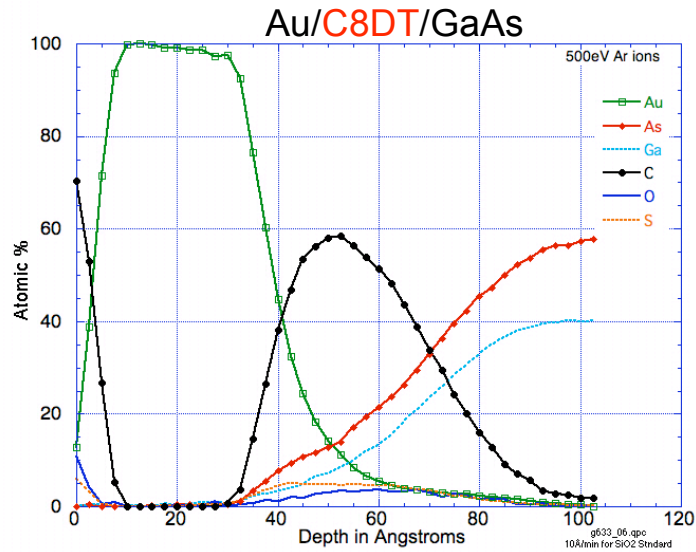


BEEM of Au/molecule/Au/GaAs



Au penetrates C16MT, but not C8DT

Structural Characterization of Diodes



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Summary

- SAM formation on GaAs \neq on Au; Thiol \neq dithiol
- Schottky barrier height much lower from I-V-T measurements than RT I-V using theoretical A^{**} ; A^{**} much smaller than ideal value
- First BEEM measurement on molecular diodes
 - BEEM threshold (1.5 eV) > I-V barrier height (0.7-0.8 eV)
 - Ballistic transport through LUMO (or lowest unoccupied interfacial states)
 - Au penetration in C16MT: lower BEEM threshold due to inhomogeneous junctions
- Low transmission in Au/C8DT/GaAs
 - Also low in A^{**} ; BEEM following the same trend as I-V-T
 - Disordered S-GaAs interface?
 - Interfacial charges/dipoles?
 - Tunneling through insulating layer?